



BB184

UHF low voltage variable capacitance diode

Rev. 3 — 6 September 2011

Product data sheet

1. Product profile

1.1 General description

The BB184 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD523 (SC-79) ultra small SMD plastic package.

1.2 Features and benefits

- Very steep CV curve
- $C_{d(1V)}$: 14 pF; $C_{d(10V)}$: 2 pF
- $C_{d(1V)}$ to $C_{d(10V)}$ ratio: typical 7
- Ultra small SMD plastic package.

1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Tuning in low voltage television.

2. Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Symbol
1	cathode		
2	anode		

sym008

3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB184	-	plastic surface mounted package; 2 leads	SOD523

4. Marking

Table 3. Marking

Type number	Marking code
BB184	A2



5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

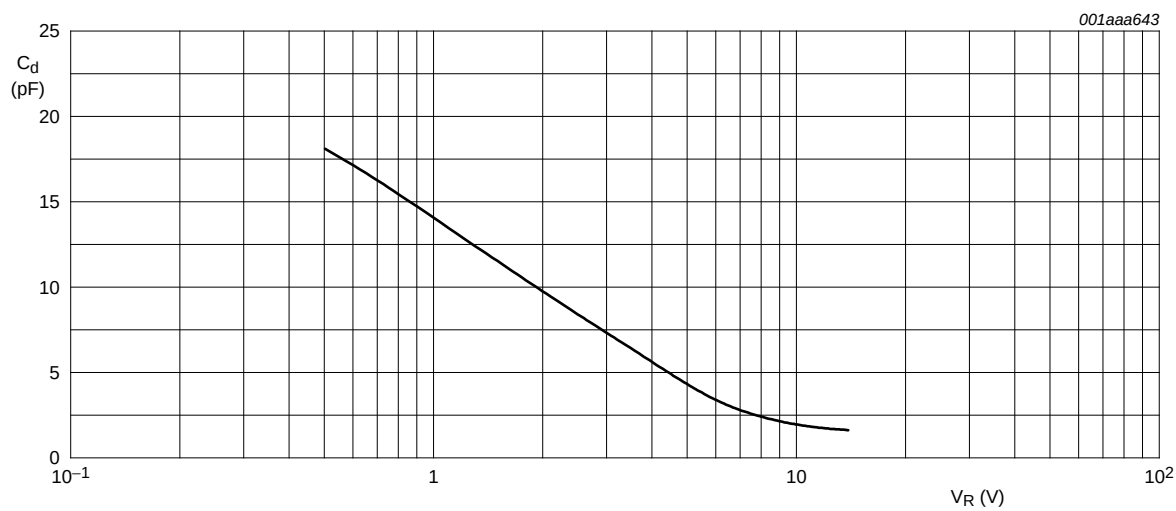
Symbol	Parameter	Conditions	Min	Max	Unit
V_R	continuous reverse voltage		-	13	V
I_F	continuous forward current		-	10	mA
T_{stg}	storage temperature		-55	+150	°C
T_j	operating junction temperature		-55	+125	°C

6. Characteristics

Table 5. Electrical characteristics

$T_j = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_R	reverse current	$V_R = 10\text{ V}$; see Figure 2	-	-	10	nA
		$V_R = 10\text{ V}$; $T_j = 85\text{ °C}$; see Figure 2	-	-	200	nA
r_s	diode series resistance	$f = 470\text{ MHz}$; $C_d = 9\text{ pF}$	-	0.65	-	Ω
C_d	diode capacitance	$f = 1\text{ MHz}$; see Figure 1 and 3				
		$V_R = 1\text{ V}$	12.7	14	15.3	pF
		$V_R = 4\text{ V}$	-	5.5	-	pF
		$V_R = 10\text{ V}$	1.87	2	2.13	pF
$\frac{C_{d(1V)}}{C_{d(10V)}}$	capacitance ratio	$f = 1\text{ MHz}$	6	7	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 1\text{ to }10\text{ V}$; in a sequence of 5 diodes (gliding)	-	-	2	%



$f = 1 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$.

Fig. 1. Diode capacitance as a function of reverse voltage; typical values.

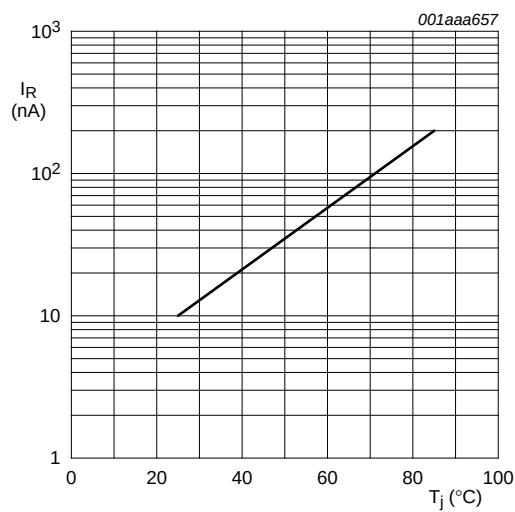


Fig. 2. Reverse current as a function of junction temperature; maximum values.

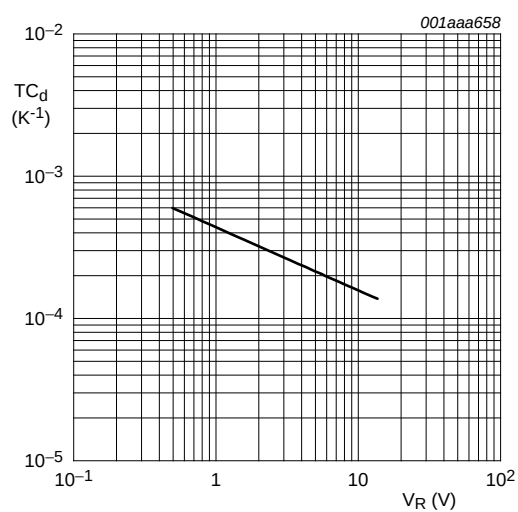


Fig. 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

7. Package outline

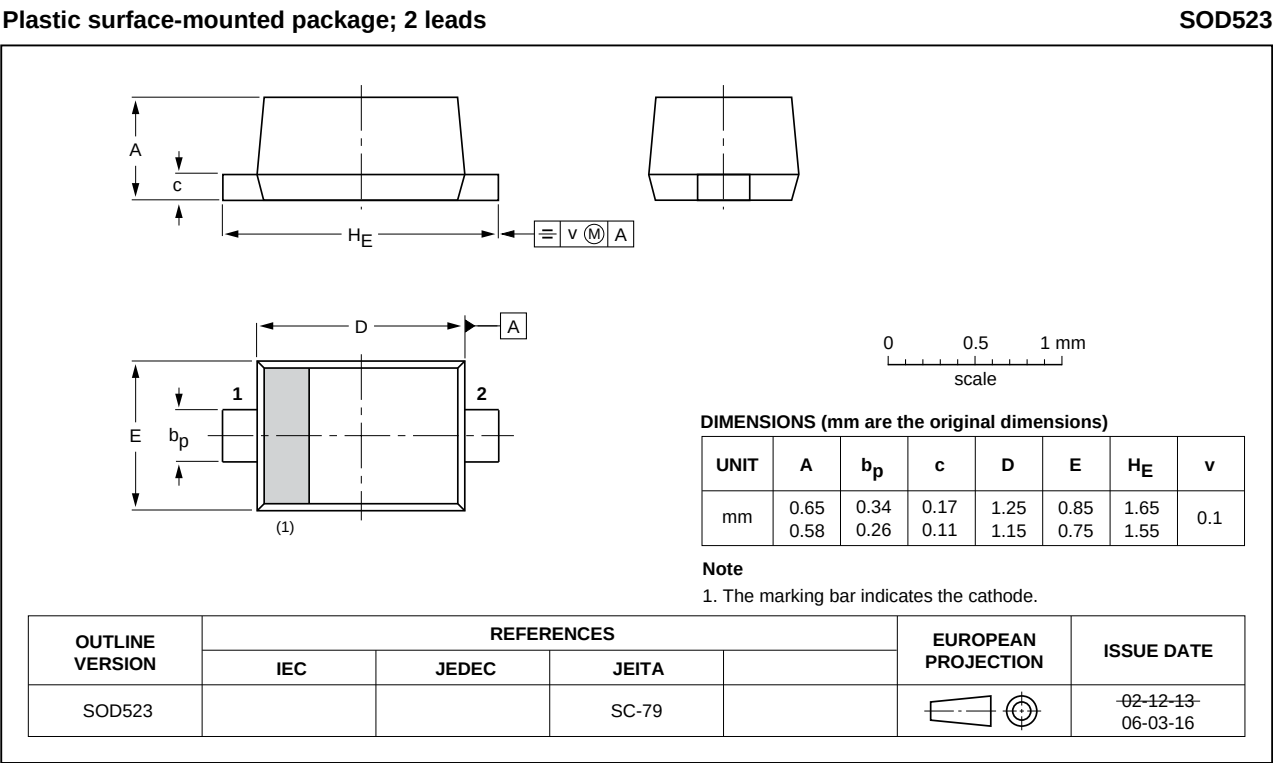


Fig 4. Package outline.

8. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB184 v.3	20110906	Product data sheet	-	BB184 v.2
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Package outline drawings have been updated to the latest version.			
BB184 v.2 (9397 750 13004)	20040422	Product data	-	BB184_N v.1
BB184_N v.1 (9397 750 12694)	20040114	Preliminary data	-	-

9. Legal information

9.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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